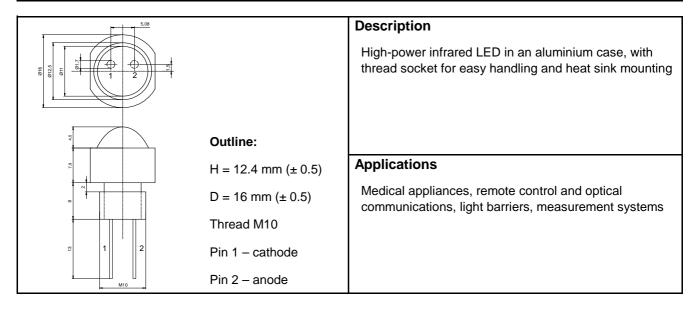
Jumbo-LED ELJ-830-629

07.05.2008

rev. 01

Radiation	Туре	Technology	Case	
Infrared	4 W	AlGaAs/AlGaAs	Plastic lens, metal case	



Absolute Maximum Ratings

at $T_{amb} = 25$ °C, on heat sink (S \geq 200 cm²), unless otherwise specified

Parameter	Test conditions	Symbol	Value	Unit
DC forward current	on heat sink		1.2	А
Peak forward current	t _p ≤100 μs, D = 0,05 I _{FM}		2.0	А
Power dissipation	on heat sink	Р	2.8	W
Operating temperature range	on heat sink	T_{amb}	-25 to +100	°C
Storage temperature range	on heat sink	T _{stg}	-25 to +100	C
Junction temperature	on heat sink	Tj	100	Q

Electrical Characteristics

T_{amb} = 25℃, unless otherwise specified

Parameter	Test conditions	Symbol	Min	Тур	Max	Unit
Forward voltage	I _F = 350 mA	V_{F}		1.6	1.9	V
Forward voltage*	I _F = 1000 mA	V_{F}		2.0	2.4	V
Switching time	I _F = 350 mA	t _r , t _f		20		ns
Reverse voltage	I _R = 10 μA	V _R	5			
Thermal resistance junction-case		R _{thJC}		10		K/W

^{*}only recommended on optimal heat sink

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Optical Characteristics

at T_{amb} = 25°C, on heat sink (S \geq 200 cm²), unless otherwise specified

Parameter	Test conditions	Symbol	Min	Тур	Max	Unit
Radiant power	I _F = 350 mA	Φ_{e}	80	100		mW
Radiant power*	I _F = 1000 mA	Φ_{e}		270		mW
Radiant intensity	I _F = 350 mA	I_{e}	450	750		mW/sr
Radiant intensity*	I _F = 1000 mA	I_{e}		2100		mW/sr
Peak wavelength	I _F = 350 mA	λ_{p}	820	830	840	nm
Spectral bandwidth at 50%	I _F = 350 mA	$\Delta\lambda_{0.5}$		35		nm
Full viewing angle	I _F = 350 mA	2φ		20		deg

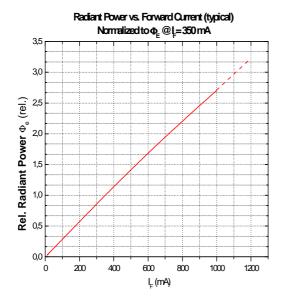
^{*}only recommended on optimal heat sink

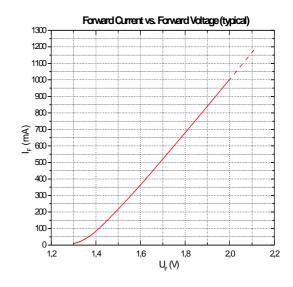
Note: All measurements carried out with *EPIGAP* equipment, on blank aluminium heat sink, S = 180 cm², passive cooling. Measurement results and curve characteristics obtained with other heat sinks may differ.

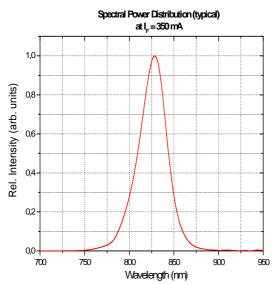
EPIGAP Optoelektronik GmbH, D-12555 Berlin, Köpenicker Str.325 b, Haus 201 Tel.: +49-30-6576 2543, Fax: +49-30-6576 2545

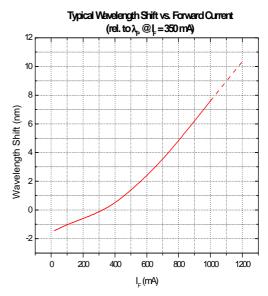
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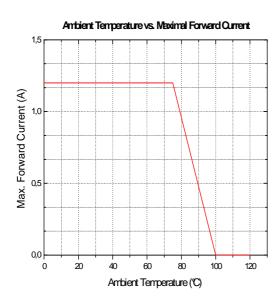
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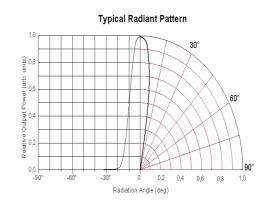












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Remarks concerning optical radiation safety*

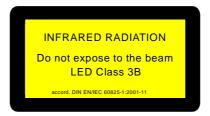
This LED may be classified as LED product Class 1 according to standard IEC 60825-1:A2 at low forward current (<100 mA) and continuous operation. *Class 1* products are safe to eyes and skin under reasonable predictable conditions. This implicates a direct observation of the light beam by means of optical instruments.

This product should be classified as LED product Class 1M according to standard IEC 60825-1:A2 if driven with higher continuous forward current (up to 700 mA). Class 1M products are safe to eyes and skin under normal conditions, even when users look into the light beam directly. Class 1M products produce either a highly divergent beam or a large diameter beam, so only a small part of the whole radiation beam can enter the eye. However, such optical products can be harmful to the retina using magnifying optical instruments. Therefore, users should not incorporate optics that could focus the output into the eyes.

If it is intended to operate the LED at very high continuous current (>1 A), this product has to be (potentially) classified as *Class 3B* LED. *Class 3B* LEDs may have sufficient power to cause an eye injury both by the direct beam and by reflections therefore these products are considered hazardous to the eye. However, the extent and severity of any eye injury arising from an exposure to the light beam of a *Class 3B* product will depend upon several factors including the radiant power entering the eye and the duration of the exposure. Nonetheless, adequate precautions should be taken to avoid direct or indirect looking into the beam.

*Note: Safety classification of an optical component mainly depends on the intended application and the way the component is being used. Furthermore, all statements made to classification are based on calculations and are only valid for this LED "as it is" and at continuous operation. Using pulsed current or altering the radiation beam with additional optics may lead to different safety classifications. Therefore these remarks should be taken as recommendation and guideline only.





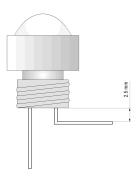
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Handling precautions

To prevent damage to the LED during soldering and assembly, following precautions have to be taken into account.

a) The bending point of the lead frame should be located at least 2.5 mm away from the body.



c) To ensure an adequate strain relief, the lead frames have to be firmly fixed during soldering.



b) While bending, the base of the lead frame has to be fixed with radio pliers or similar.



d) To avoid any damage of the LED during soldering the lead frames should not be distorted especially when they have been heated



e) LEDs are static sensitive devices, so adequate handling precautions have to be taken, e.g. wearing grounding wrist straps.



ESD